

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE

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**Environmental testing –  
Part 3-13: Supporting documentation and guidance on Test T – Soldering**

**Essais d'environnement –  
Partie 3-13: Documentation d'accompagnement et guide sur les essais T –  
Brasage**



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## CONTENTS

FOREWORD.....	4
1 Scope.....	6
2 Normative references.....	6
3 Terms, definitions and abbreviations .....	6
3.1 Terms and definitions .....	6
3.2 Abbreviations .....	7
4 Overview .....	7
4.1 Factors influencing the formation and reliability of solder joints (ability to be soldered) .....	7
4.2 Physics of surface wetting .....	8
4.3 Quality and reliability of solder joints .....	10
5 Component soldering – Processes .....	10
5.1 General considerations.....	10
5.1.1 Components' ability to be soldered .....	10
5.1.2 Soldering processes.....	12
5.1.3 Soldering defects .....	12
5.1.4 Geometrical factors which may influence the soldering result.....	12
5.1.5 Process factors .....	12
5.1.6 Material factors .....	12
5.2 Solder.....	13
5.3 Grouping of soldering conditions .....	13
5.4 Ability to be soldered.....	13
5.5 Moisture sensitivity of component.....	13
5.6 Relation between storage time/storage conditions and solderability.....	14
5.6.1 Natural and accelerated ageing.....	14
5.6.2 Oxidation .....	14
5.6.3 Growth of intermetallic layers .....	14
5.6.4 Effect of ageing on wetting characteristics .....	14
5.6.5 Test conditions for accelerated ageing.....	15
5.7 Place of soldering tests in testing .....	16
6 Soldering tests .....	17
6.1 General.....	17
6.2 Solder .....	18
6.3 Fluxes .....	18
6.4 Test equipment .....	18
6.5 Evaluation methods.....	18
6.5.1 Criteria for visual inspection .....	18
6.5.2 Criteria for quantitative evaluation of the wetting characteristic .....	19
6.5.3 Special cases .....	19
6.6 Acceptance criteria .....	19
7 Soldering tests – Methods.....	19
7.1 General principles .....	19
7.2 Survey of test methods.....	19
7.3 Bath test .....	22
7.4 Reflow test.....	23
7.4.1 With/without solder land .....	23

7.4.2	Selection of solder paste (flux system and activity grade).....	23
7.5	Soldering iron test.....	23
7.6	Resistance to dissolution of metallization and soldering heat.....	23
7.6.1	General .....	23
7.6.2	Limitations .....	23
7.6.3	Choice of severity .....	24
7.7	Wetting balance test.....	24
7.7.1	General .....	24
7.7.2	Test methods available .....	25
7.7.3	Limitations .....	25
8	Requirements and statistical character of results.....	25
	Bibliography .....	27
	Figure 1 – Sessile drop of solder on oxidised copper .....	8
	Figure 2 – Sessile drop of solder plus flux on clean copper.....	9
	Figure 3 – Sessile drop equilibrium forces .....	9
	Figure 4 – Typical soldering processes.....	12
	Figure 5 – Soldering tests for devices with leads .....	21
	Figure 6 – Soldering tests for SMDs .....	22
	Table 1 – Solder process groups.....	13

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## ENVIRONMENTAL TESTING –

## Part 3-13: Supporting documentation and guidance on Test T – Soldering

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International Standard IEC 60068-3-13 has been prepared by IEC technical committee 91: Electronic assembly technology.

This first edition cancels and replaces IEC 60068-2-44:1995 and constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- information for lead-free solders are added;
- technical update and restructuring.

The text of this standard is based on the following documents:

FDIS	Report on voting
91/1345/FDIS	91/1356/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 60068 series, published under the general title *Environmental testing*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
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## ENVIRONMENTAL TESTING –

### Part 3-13: Supporting documentation and guidance on Test T – Soldering

#### 1 Scope

This part of IEC 60068 provides background information and guidance for writers and users of specifications for electric and electronic components, containing references to the test standards IEC 60068-2-20, IEC 60068-2-58, IEC 60068-2-69, IEC 60068-2-83, and to IEC 61760-1, which defines requirements to the specification of surface mounting components.

#### 2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-2-20:2008, *Environmental testing – Part 2: Tests – Test T: Test methods for solderability and resistance to soldering heat of devices with leads*

IEC 60068-2-58, *Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metalization and to soldering heat of surface mounting devices (SMD)*

IEC 60068-2-69, *Environmental testing – Part 2-69: Tests – Test Te: Solderability testing of electronic components for surface mounting devices (SMD) by the wetting balance method<sup>1</sup>*

IEC 60068-2-83, *Environmental testing – Part 2-83: Tests – Test Tf: Solderability testing of electronic components for surface mounting devices (SMD) by the wetting balance method using solder paste*

IEC 61760-1, *Surface mounting technology – Part 1: Standard method for the specification of surface mounting components (SMDs)*

IEC 62137-3, *Electronic assembly technology – Part 3: Selection guidance of environmental and endurance test methods for solder joints*

#### 3 Terms, definitions and abbreviations

##### 3.1 Terms and definitions

For the purposes of this document the following terms and definitions apply.

###### 3.1.1

###### **solderability**

ability of the lead, termination or electrode of a component to be wetted by solder at the temperature of the termination or electrode, which is assumed to be the lowest temperature in the soldering process within the applicable temperature range of the solder alloy

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<sup>1</sup> A new edition (third edition) is currently under consideration.